

Automatic Wafer Bonding Equipment Market, Global Outlook and Forecast 2022-2028

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Abstracts

This report contains market size and forecasts of Automatic Wafer Bonding Equipment in global, including the following market information:

Global Automatic Wafer Bonding Equipment Market Revenue, 2017-2022, 2023-2028, (\$ millions)

Global Automatic Wafer Bonding Equipment Market Sales, 2017-2022, 2023-2028, (K Units)

Global top five Automatic Wafer Bonding Equipment companies in 2021 (%)

The global Automatic Wafer Bonding Equipment market was valued at million in 2021 and is projected to reach US\$ million by 2028, at a CAGR of % during the forecast period 2022-2028.

The U.S. Market is Estimated at \$ Million in 2021, While China is Forecast to Reach \$ Million by 2028.

Fully Automatic Segment to Reach \$ Million by 2028, with a % CAGR in next six years.

The global key manufacturers of Automatic Wafer Bonding Equipment include EV Group, SUSS MicroTec, Tokyo Electron, Applied Microengineering, Nidec Machinetool, Ayumi Industry, Shanghai Micro Electronics, U-Precision Tech and Hutem, etc. In 2021, the global top five players have a share approximately % in terms of revenue.

MARKET MONITOR GLOBAL, INC (MMG) has surveyed the Automatic Wafer Bonding

Equipment manufacturers, suppliers, distributors and industry experts on this industry, involving the sales, revenue, demand, price change, product type, recent development and plan, industry trends, drivers, challenges, obstacles, and potential risks.

Total Market by Segment:

Global Automatic Wafer Bonding Equipment Market, by Type, 2017-2022, 2023-2028 (\$ Millions) & (K Units)

Global Automatic Wafer Bonding Equipment Market Segment Percentages, by Type, 2021 (%)

Fully Automatic

Semi-automatic

Global Automatic Wafer Bonding Equipment Market, by Application, 2017-2022, 2023-2028 (\$ Millions) & (K Units)

Global Automatic Wafer Bonding Equipment Market Segment Percentages, by Application, 2021 (%)

MEMS

Advanced Packaging

CIS

other

Global Automatic Wafer Bonding Equipment Market, By Region and Country, 2017-2022, 2023-2028 (\$ Millions) & (K Units)

Global Automatic Wafer Bonding Equipment Market Segment Percentages, By Region and Country, 2021 (%)

North America

US

Canada

Mexico

Europe

Germany

France

U.K.

Italy

Russia

Nordic Countries

Benelux

Rest of Europe

Asia

China

Japan

South Korea

Southeast Asia

India

Rest of Asia

South America

Brazil

Argentina

Rest of South America

Middle East & Africa

Turkey

Israel

Saudi Arabia

UAE

Rest of Middle East & Africa

Competitor Analysis

The report also provides analysis of leading market participants including:

Key companies Automatic Wafer Bonding Equipment revenues in global market, 2017-2022 (Estimated), (\$ millions)

Key companies Automatic Wafer Bonding Equipment revenues share in global market, 2021 (%)

Key companies Automatic Wafer Bonding Equipment sales in global market, 2017-2022 (Estimated), (K Units)

Key companies Automatic Wafer Bonding Equipment sales share in global market, 2021 (%)

Further, the report presents profiles of competitors in the market, key players include:

EV Group

SUSS MicroTec

Tokyo Electron

Applied Microengineering

Nidec Machinetool

Ayumi Industry

Shanghai Micro Electronics

U-Precision Tech

Hutem

Canon

Bondtech

TAZMO

TOK

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